

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6864477

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TOMOHIRO KYOTANI	06/04/2021
EIJI DEJIMA	06/04/2021
NAOKO SUMITANI	06/04/2021
TOMOHIRO KATO	06/04/2021
TAKESHI SAWAI	06/04/2021
RECEIVING PARTY DATA	
Name:	Mitsubishi Chemical Corporation
Street Address:	1-1, Marunouchi 1-chome, Chiyoda-ku
City:	Tokyo
State/Country:	Japan
Postal Code:	100-8251
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17402013
CORRESPONDENCE DATA	
Fax Number:	(703)413-2220
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	(703) 413-3000
Email:	ktillman@oblon.com
Correspondent Name:	OBLON, ET AL.
Address Line 1:	1940 DUKE STREET
Address Line 4:	ALEXANDRIA, VIRGINIA 22314
ATTORNEY DOCKET NUMBER:	538672US
NAME OF SUBMITTER:	KAYLA TILLMAN
SIGNATURE:	/Kayla Tillman/
DATE SIGNED:	08/13/2021
Total Attachments: 5 source=ASN#page1.tif	

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**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN
APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE**

Title of Invention	SILICA PARTICLE AND PRODUCTION METHOD THEREFOR, SILICA SOL, POLISHING COMPOSITION, POLISHING METHOD, METHOD FOR PRODUCING SEMICONDUCTOR WAFER AND METHOD FOR PRODUCING SEMICONDUCTOR DEVICE
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As the below named inventor, I hereby declare that:

This declaration ☒ The attached application, or
is directed to: ☐ United States application or PCT international application number _____
filed on _____

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

WHEREAS, Mitsubishi Chemical Corporation
(hereinafter referred to as "ASSIGNEE") having places of business at: 1-1, Marunouchi 1-chome, Chiyoda-ku,
Tokyo 100-8251 Japan, is desirous of acquiring the entire right, title and interest in and to said invention and in and
to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and
all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby
acknowledged, and for other good and valuable consideration, I, by these presents do sell, assign and transfer unto
said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions
and in all foreign countries (including the right to claim priority under the terms of the International Convention and
other relevant International Treaties and Arrangements from the aforesaid application) and the entire right, title and
interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial
possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations,
substitutions and renewals thereof.

I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and
any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the
assignee of my entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its
(his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and
entirely as the same would have been held by me had this Assignment and sale not been made.

Further, I agree that I will communicate to said ASSIGNEE or its (his) representatives any facts known to me
respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional,
continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and
all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything
possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said
invention in the United States and its territorial possessions and in any and all foreign countries.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001
by fine or imprisonment of not more than five (5) years, or both.

LEGAL NAME OF INVENTOR	
Inventor: <u>Tomohiro KYOTANI</u>	Date: <u>June 4, 2021</u>
Signature: <u>Tomohiro KYOTANI</u>	

OBLON, McCLELLAND, MAIER & NEUSTADT, L.L.P.
ATTORNEYS AT LAW
1940 DUKE STREET
ALEXANDRIA, VIRGINIA 22314

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As the below named inventor, I hereby declare that: This declaration ☒ The attached application, or is directed to: ☐ United States application or PCT international application number _____ filed on _____ The above-identified application was made or authorized to be made by me. I believe that I am the original inventor or an original joint inventor of a claimed invention in the application. WHEREAS, <u>Mitsubishi Chemical Corporation</u> (hereinafter referred to as "ASSIGNEE") having places of business at: <u>1-1, Marunouchi 1-chome, Chiyoda-ku,</u> <u>Tokyo 100-8251 Japan</u>, is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries; NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I, by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries (including the right to claim priority under the terms of the International Convention and other relevant International Treaties and Arrangements from the aforesaid application) and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof. I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me had this Assignment and sale not been made. Further, I agree that I will communicate to said ASSIGNEE or its (his) representatives any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries. I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.	
LEGAL NAME OF INVENTOR	
Inventor: <u>Eiji DEJIMA</u> Date: <u>June 4, 2021</u>	
Signature: <u>Eiji DEJIMA</u>	

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LEGAL NAME OF INVENTOR	
Inventor: <u>Naoko SUMITANI</u>	Date: <u>June 4th, 2021</u>
Signature: <u>Naoko Sumitan</u>	

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LEGAL NAME OF INVENTOR	
Inventor: <u>Tomohiro KATO</u>	Date: <u>June 4, 2021</u>
Signature: <u>Tomohiro KATO</u>	

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LEGAL NAME OF INVENTOR	
Inventor: <u>Takeshi SAWAI</u>	Date: <u>June 4, 2021</u>
Signature: <u>Takeshi Sawai</u>	

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